

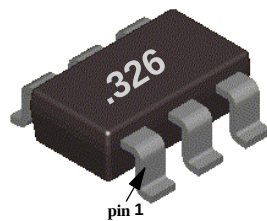
FDC6326L Integrated Load Switch

General Description

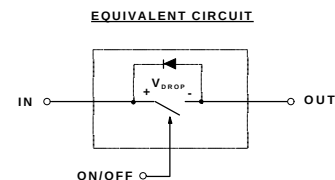
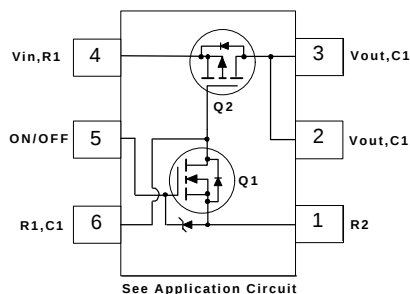
This device is particularly suited for compact power management in portable electronic equipment where 3V to 20V input and 1.8A output current capability are needed. This load switch integrates a small N-Channel power MOSFET (Q1) which drives a large P-Channel power MOSFET (Q2) in one tiny SuperSOT™-6 package.

Features

- $V_{DROP}=0.20V$ @ $V_{IN}=12V$, $I_L=1.5A$, $R_{DS(ON)} = 0.125 \Omega$
 $V_{DROP}=0.20V$ @ $V_{IN}=5V$, $I_L=1A$, $R_{DS(ON)} = 0.20 \Omega$.
- SuperSOT™-6 package design using copper lead frame for superior thermal and electrical capabilities.



SuperSOT™-6



Absolute Maximum Ratings $T_A = 25^\circ C$ unless otherwise noted

Symbol	Parameter	FDC6326L	Units
V_{IN}	Input Voltage Range	3 - 20	V
$V_{ON/OFF}$	On/Off Voltage Range	2.5 - 8	V
I_L	Load Current - Continuous (Note 1)	1.8	A
	- Pulsed (Note 1 & 3)	5	
P_D	Maximum Power Dissipation (Note 2)	0.7	W
T_J, T_{STG}	Operating and Storage Temperature Range	-55 to 150	$^\circ C$
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf/1500Ohm)	6	kV

THERMAL CHARACTERISTICS

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	180	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	60	$^\circ C/W$

Electrical Characteristics (T _A = 25°C unless otherwise noted)						
Symbol	Parameter	Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
I _{FL}	Forward Leakage Current	V _{IN} = 20 V, V _{ON/OFF} = 0 V			1	μA
ON CHARACTERISTICS (Note 3)						
V _{DROP}	Conduction Voltage Drop	V _{IN} = 12 V, V _{ON/OFF} = 3.3 V, I _L = 1.5 A		0.15	0.2	V
		V _{IN} = 5 V, V _{ON/OFF} = 3.3 V, I _L = 1 A		0.14	0.2	
R _{DS(ON)}	Q ₂ - Static On-Resistance	V _{GS} = -12 V, I _D = -1.9 A		0.095	0.125	Ω
		V _{GS} = -5 V, I _D = -1.5 A		0.14	0.2	
I _L	Load Current	V _{DROP} = 0.125 V, V _{IN} = 12 V, V _{ON/OFF} = 3.3 V	1			A
		V _{DROP} = 0.20 V, V _{IN} = 5 V, V _{ON/OFF} = 3.3 V	1			

Notes:
1. V_{IN}=20V, V_{ON/OFF}=8V, T_A=25°C
2. R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θJC} is guaranteed by design while R_{θCA} is determined by the user's board design.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2.0%.

FDC6326L Load Switch Application

APPLICATION CIRCUIT

External Component Recommendation

First select R2, 100 - 1kΩ, for Slew Rate control.
C1 ≤ 1000pF can be added in addition to R2 for further In-rush current control.
Then select R1 such that R1/R2 ratio maintains between 10 - 100. R1 is required to turn Q2 off.
For SPICE simulation, users can download a "FDC6326L.MOD" Spice model from Fairchild Web Site at www.fairchildsemi.com

Typical Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

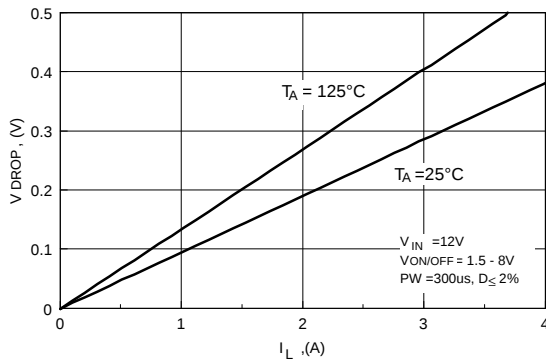


Figure 1. Conduction Voltage Drop Variation with Load Current.

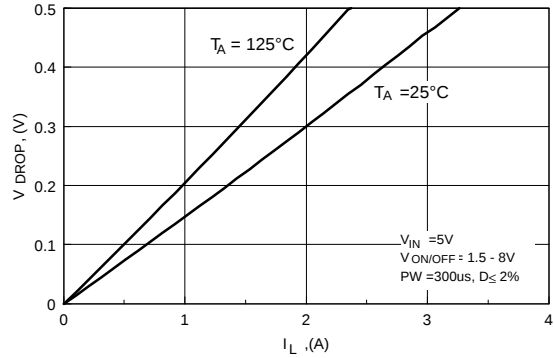


Figure 2. Conduction Voltage Drop Variation with Load Current.

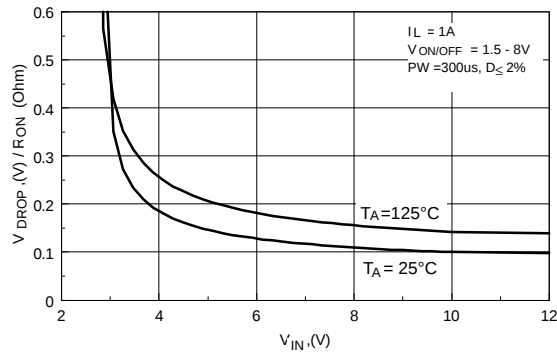


Figure 3. On-Resistance Variation with Input Voltage.

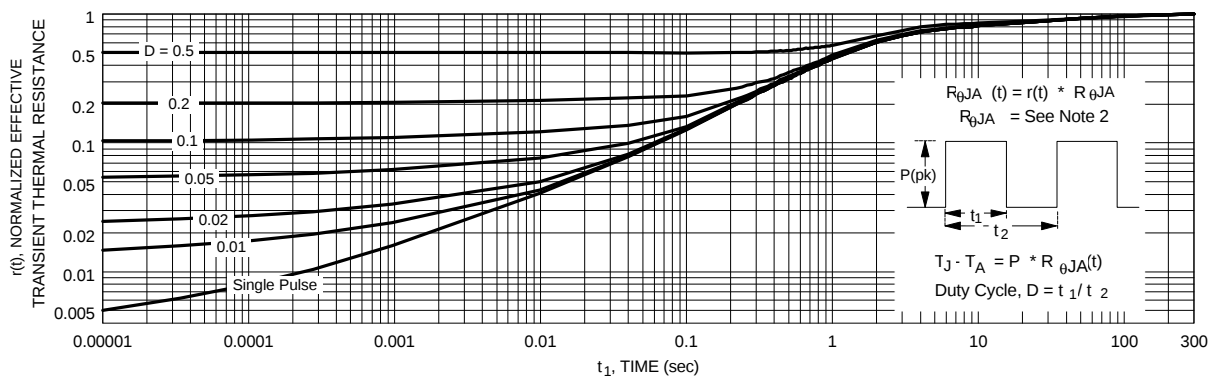


Figure 4. Transient Thermal Response Curve.

Thermal characterization performed on the conditions described in Note 2.

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